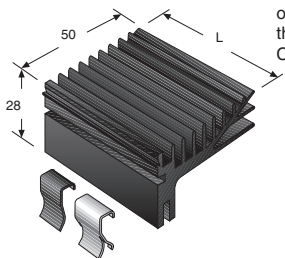**TO220 package**

KL series

High power dissipation, extruded heatsinks designed to accommodate one or more TO220 packages via clips (available separately) or a threaded slot. Shaped to minimise board space by overhanging adjacent components. Additional threaded slot in base aids assembly. Choice of thermal resistance.

50

28

L

Th. Res.	Length (L)	Manf. Part No. & Order Code
3.4°C/W	100mm	KL100-1
Device retaining clip (with legs)		4426
Device retaining clip (without legs for space saving)		4525